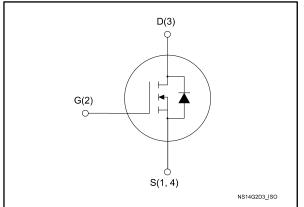
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STE60N105DK5

Datasheet - production data

N-channel 1050 V, 0.110 Ω typ., 46 A MDmesh[™] DK5 Power MOSFET in an ISOTOP package

Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ID	Ртот
STE60N105DK5	1050 V	0.120 Ω	46 A	680 W

- Fast-recovery body diode
- Best R_{DS(on)} x area
- Low gate charge, input capacitance and resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is part of the MDmeshTM DK5 fast recovery diode series. The MDmeshTM DK5 combines very low recovery charge (Qrr) and recovery time (trr) with an excellent improvement in R_{DS(on)} * area and one of the most effective switching behaviors, ideal for half bridge and full bridge converters.

Table 1: Device summary

Order code	Marking	Packages	Packaging
STE60N105DK5	60N105DK5	ISOTOP	Tube

December 2016

DocID024137 Rev 2

This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±30	V
	Drain current (continuous) at T _C = 25 °C	46	А
lo	Drain current (continuous) at Tc = 100 °C	30	А
IDM ⁽¹⁾	Drain current (pulsed)	184	А
Ртот	Total dissipation at $T_c = 25 \text{ °C}$	680	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	50	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
Viso	Insulation withstand voltage (AC-RMS)	2.5	kV
Tj	Operating junction temperature range	55 to 450	*0
T _{stg}	Storage temperature range	-55 to 150	°C

Notes:

 $^{(1)}\mbox{Pulse}$ width limited by safe operating area

 $^{(2)}I_{SD} \leq 23$ A, di/dt ≤ 400 A/µs; V_{DS peak} $\leq V_{(BR)DSS},$ V_{DD} = 525 V $^{(3)}V_{DS} \leq 840$ V

Table 3: Thermal data

Symbol	Parameter	Value	Unit	
R _{thj-case}	Thermal resistance junction-case	0.184	°C/W	
R _{thj-amb}	Thermal resistance junction-ambient	30	C/VV	

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
las	Single pulse avalanche energy (pulse width limited by T_{JMAX})	16	А
Eas	Single pulse avalanche energy (starting $T_J = 25^{\circ}C$, $I_D = I_{AS}$, $V_{DD} = 50 \text{ V}$)	1550	mJ



2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

	Table 5: On /on states					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	1050			V
	IDSS Zero gate voltage drain	V_{DS} = 1050 V, V_{GS} = 0 V			1	μA
IDSS					50	μA
I _{GSS}	Gate-body leakage current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	Vgs = 10 V, Id = 23 A		0.110	0.120	Ω

Table 5: On /off states

Notes:

⁽¹⁾Defined by design, not subject to production test

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	6675	-	pF
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz, V _{GS} = 0 V	-	370	-	pF
Crss	Reverse transfer capacitance	VGS = 0 V	-	10	-	pF
Co(tr) ⁽¹⁾	Equivalent capacitance time related		-	630	-	pF
Co(er) ⁽²⁾	Equivalent capacitance energy related	V _{GS} = 0 V, V _{DS} = 0 to 840 V	-	219	-	
Rg	Intrinsic gate resistance	f = 1 MHz open drain	-	3	-	Ω
Qg	Total gate charge	$V_{DD} = 840 V, I_D = 46 A,$	-	204	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	36	-	nC
Q _{gd}	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	133	-	nC

Table 6: Dynamic

Notes:

 $^{(1)}$ Time related is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

 $^{(2)} Energy$ related is defined as a constant equivalent capacitance giving the same stored energy as C_{OSS} when V_{DS} increases from 0 to 80% V_{DSS} .

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Electrical characteristics

Table 7: Switching times							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t _{d(on)}	Turn-on delay time	V _{DD} = 525 V, I _D = 23 A,	-	40.6	-	ns	
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$	-	64.5	-	ns	
t _{d(off)}	Turn-off delay time	(see Figure 14: "Test circuit for resistive load switching times"	-	262	-	ns	
tr	Fall time	and Figure 19: "Switching time waveform")	-	49.5	-	ns	

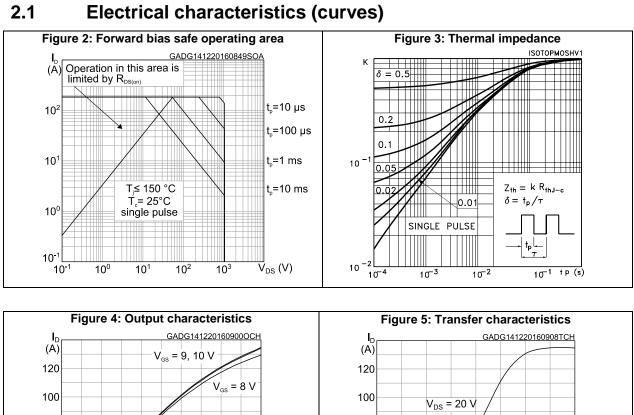
Table 8: Source drain diode

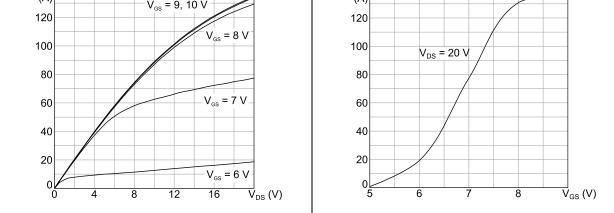
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		46	Α
Isdm	Source-drain current (pulsed)		-		184	А
V _{SD} ⁽¹⁾	Forward on voltage	I _{SD} = 46 A, V _{GS} = 0 V	-		1.5	V
trr	Reverse recovery time	I _{SD} = 46 A, V _{DD} = 60 V,	-	273		ns
Qrr	Reverse recovery charge	di/dt = 100 A/µs (see <i>Figure 16: "Test circuit for</i>	-	3		μC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	23		A
trr	Reverse recovery time	I _{SD} = 46 A, V _{DD} = 60 V,	-	477		ns
Qrr	Reverse recovery charge	di/dt = 100 A/ μ s, T _j = 150 °C (see <i>Figure 16: "Test circuit for</i>	-	10		μC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	42		A

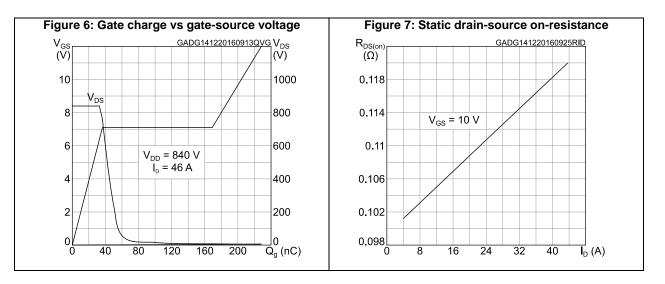
Notes:

 $^{(1)}\text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%







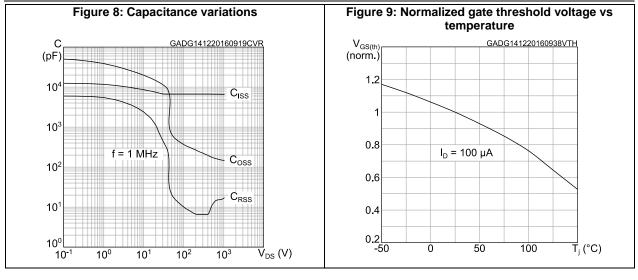


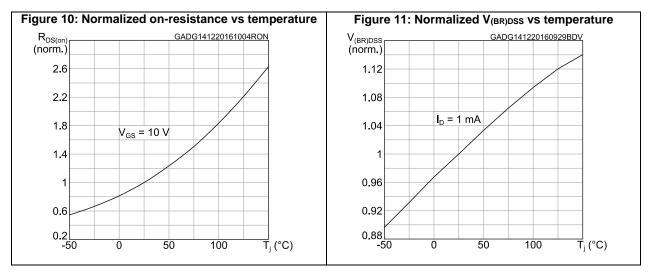
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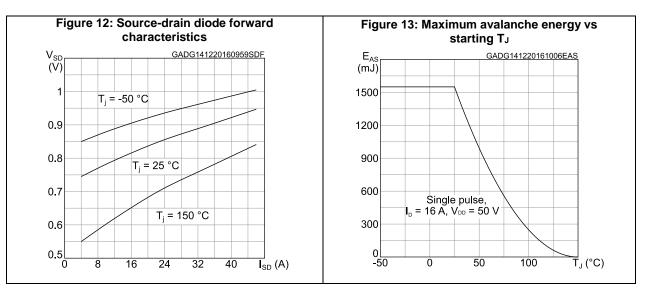


STE60N105DK5

Electrical characteristics





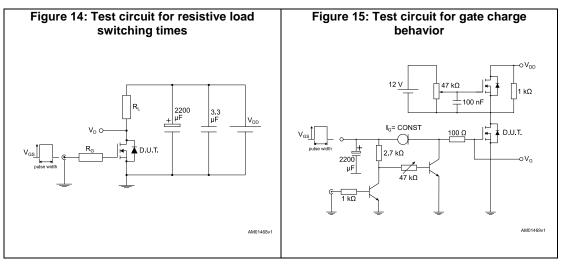


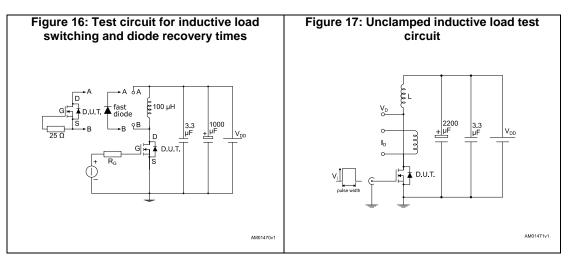
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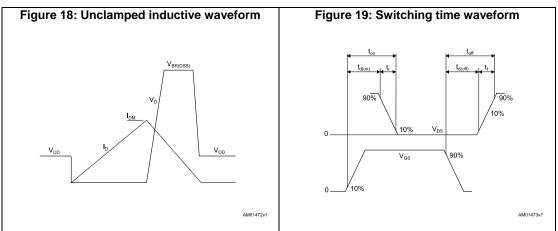
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3 Test circuits









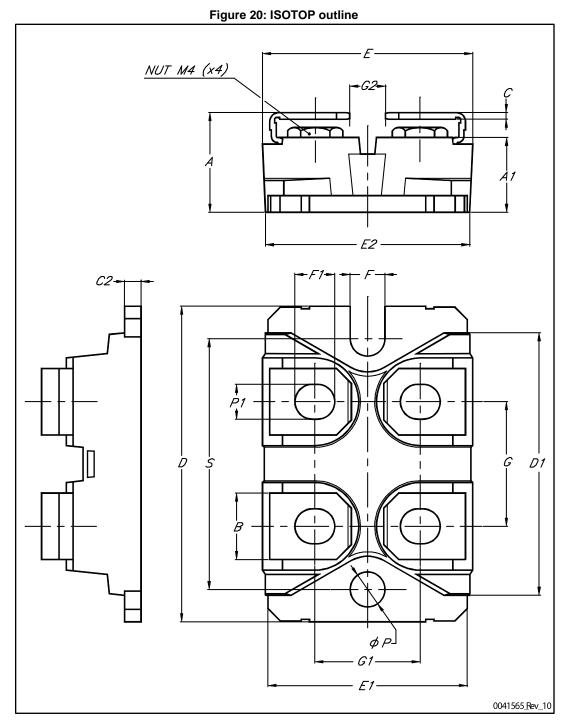


4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



4.1 **ISOTOP** package information



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Package information

Table 9: ISOTOP mechanical data					
Dim		mm			
Dim.	Min.	Тур.	Max.		
A	11.80		12.20		
A1	8.90		9.10		
В	7.80		8.20		
С	0.75		0.85		
C2	1.95		2.05		
D	37.80		38.20		
D1	31.50		31.70		
E	25.15		25.50		
E1	23.85		24.15		
E2		24.80			
G	14.90		15.10		
G1	12.60		12.80		
G2	3.50		4.30		
F	4.10		4.30		
F1	4.60		5		
ØP	4		4.30		
P1	4		4.40		
S	30.10		30.30		



5 Revision history

Table 10: Document revision history	Table	10: Document	revision	history
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Date	Revision	Changes
24-Jan-2013	1	First release
16-Dec-2016	2	Datasheet status promoted from preliminary to production data. Updated title, features, description and internal schematic diagram on cover page. Updated Section 1: "Electrical ratings". Updated Section 2: "Electrical characteristics". Added Section 2.1: "Electrical characteristics (curves)". Minor text changes



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